

## Literature Watch

## Buses

**VME gets facelift with new-generation processor.** Motorola offers VME cards based on PowerPC 603 and 604 RISC processors, while the PCI-based motherboard allows other processors to be used. Warren Andrews, *Computer Design*, 7/94, p. 38, 2 pp.

## Development Tools

**Program generators turn graphical ideas into source-code modules for embedded tasks.** Several tools are available that help programmers visually conceptualize software operation for embedded source-code design. Russ Lindgren, *Personal Engineering*, 7/94, p. 35, 6 pp.

## Memory

**Hot shots in new memory game.** Specialized DRAMs for particular applications are finding favor over standard DRAMs and include devices like the SDRAM (synchronous DRAM) and the RDRAM (Rambus DRAM). Mike Elphick, *OEM Magazine*, 7-8/94, p. 76, 5 pp.

**Faster processors ignite SRAM revolution.** Specialty SRAMs provide components to cache designers meeting demands of ever-faster microprocessors. Jeffrey Child, *Computer Design*, 7/94, p. 97, 3 pp.

## Miscellaneous

**Adopting multichip-module technology.** Multichip modules are worth a look to improve density and speed, but testing must not be ignored. Shiv C. Tasker, Cadence Design Systems, Zoran Sekulic, Integrated Measurement Systems; *Electronic Design*, 6/27/94, p. 153, 5 pp.

**Silicon-carbide process yields high-temperature ICs.** Any silicon foundry should be able to fabricate ICs with three times the heat range of conventional silicon ICs by using GE's silicon-carbide process; other benefits are predicted as well. David Maliniak, *Electronic Design*, 6/27/94, p. 44, 2 pp.

**Better management led to better**

**numbers.** As electronics industry sales increased moderately by 6.4% in 1993, net income nearly tripled to \$45.8 billion, resulting from increased productivity with reduced manufacturing and materials costs. Vanessa Craft, *Electronic Business Buyer*, 7/94, p. 46, 16 pp.

**Parallel visualization algorithms: performance and architectural**

**implications.** Multiprocessors supporting shared data improve image synthesis algorithms and visualization. Jaswinder Pal Singh, Anoop Gupta, et al, Stanford University, *IEEE Computer*, 7/94, p. 45, 11 pp.

**Known-good die for the same cost as**

**packaged ICs.** Intel's known-good die program, SmartDie, offers die tested to meet AC and DC parametric tests over 0°C to +80°C at the same cost as packaged equivalents. Spencer Chin, *Electronic Products*, 7/94, p. 19, 1 pp.

## Peripheral Chips

**Fast Ethernet is up to speed.** Fast Ethernet is gaining support in the transition to Asynchronous Transfer Mode. Barry Phillips, *OEM Magazine*, 7-8/94, p. 11, 3 pp.

**Vitesse, Tricord team to enable 12-Pentium multiprocessing.** Gallium-arsenide cache-controller chip set supports 12 Pentium 60/90-MHz or 66/100-MHz processors and gives zero-wait-state performance. Jeff Child, *Computer Design*, 7/94, p. 26, 1 pp.

**Hue and cry for color stirs flat-panel makers.** Demand for color in flat-panel displays is strong, and mobile computing makes demands on technology. Frank Caruthers, *Computer Design*, 7/94, p. OEMI-11, 5 pp.

## Processors

**Controller manages power and keyboards.** The power and human interface of portable systems can be managed by an 8-bit microcontroller, the Hitachi H8/3437 IKAP-II, that offloads the host. Dave Bursky, *Electronic Design*, 6/27/94, p. 181, 3 pp.

**Workstation makers fight the PC challenge.** Many CAE users like the low cost and performance of Pentium and PowerPC. James Carbone, *Electronic Business Buyer*, 7/94, p. 109, 3 pp.

**SPECmark of the month.** The MIPS R8000/R8010 two-chip set is a building block for supercomputers, as in the new Silicon Graphics Power Challenge. Rodney Myrvaagnes, *Electronic Products*, 7/94, p. 22, 2 pp.

**Massively parallel supercomputer sets record of 143.4 double-precision GFLOPS.** Intel i860XP CPUs in a 31-cabinet Sandia Labs Paragon supercomputer crack record by 15% but leave room for the future with Linpack. Clifford Meth, *Electronic Design*, 6/27/94, p. 46, 2 pp.

## System Design

**Integrate PCMCIA sockets into desktops.** Meeting design challenges when integrating PCMCIA sockets into desktop systems. Henry Fung, Vadem; *Electronic Design*, 7/11/94, p. 113, 4 pp.

**Touch screens for portables.** Resistive, electrostatic, and electromagnetic technologies are the leaders for touch handheld devices. R.D.R. Hoffman, *OEM Magazine*, 7-8/94, p. 66, 4 pp.

**Rechargeable lithium cells: power to burn for portables.** While Li-Ion and Li-Poly cells possess the greatest energy (weight) density of all batteries, design considerations must address areas including misuse protection and precise charging circuits. Chester Simpson, *OEM Magazine*, 7-8/94, p. 66, 4 pp.